

WAP321015-PCSC2

Dual Wavelength SMD Type Emitter

Features

- Side view 1204 package
- Viewing Angle = $\pm 65^{\circ}$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- RoHS compliance

Applications

- Optical indicator.
- Switch and Symbol Display.

Description

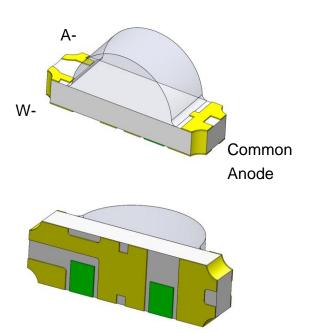
The WAP321015-PCSC2 is a double LED housed in a miniature SMD package. The device has a White and Amber LED.

Static electricity and surge damage the LEDs.

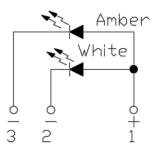
It is recommended to use a wrist band or

anti-electrostatic glove when handling the LEDs.

Package Outline



Schematic





Absolute Maximum Rating at 25°C

Symbol	Parameters		Ratings	Units	Notes
1_	Continuous Forward Current	W	25	٣A	
I _F	Continuous Forward Current	А	25	mA	
		W	60		1
IFP	IFP Peak Forward Current		60	mA	1
V _R	Reverse Voltage	5	V		
T _{opr}	pr Operating Temperature		-40 ~ +85	0 C	
T _{stg}	stg Storage Temperature		-40 ~ +100	0 C	
T _{sol}	Soldering Temperature	260	0 C	2	
D-	P _D Power Dissipation at(or below) 25°C Free Air Temperature		95	m\//	
۳D			60	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics (White)

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I⊧=5mA	112	-	285	mcd	3
λ _D	Dominant Wavelength	I⊧=5mA	-	-	-	nm	4
θ1/2	Angle of Half Intensity	I⊧=5mA	-	±65	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I⊧=5mA	2.6	-	3.2	V	
I _R	Reverse Current	V _R =5V	-	-	1	μA	

Optical Characteristics (Amber)

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I⊧=5mA	18	-	45	mcd	3
λD	Dominant Wavelength	I⊧=5mA	600	-	610	nm	4
θ1/2	Angle of Half Intensity	I⊧=5mA	-	±65	-	deg	



Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I⊧=5mA	1.6	-	2.2	V	
I _R	Reverse Current	V _R =5V	-	-	1	μA	

Notes:

- 1. IFP Conditions--Pulse Width $\leq 100 \mu s$ and Duty $\leq 10\%$.
- 2. Soldering time ≤ 10 seconds.
- 3. Bin Range of Luminous Intensity

White							
Bin Code	Min	Max	Unit	Condition			
R	112	180	mad	I _F =5mA			
S	180	285	mcd				
	Amber						
Bin Code	Min	Max	Unit	Condition			
М	18.0	28.5	mad	I⊧=5mA			
Ν	28.5	45.0	mcd	i⊧=3IIIA			

Tolerance of: Luminous Intensity $\pm 10\%$

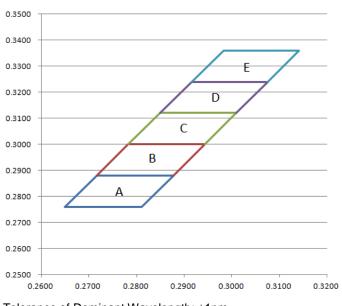


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Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
	0.2650	0.2760		0.2570	0.2760
^	0.2717	0.2880	D	0.2703	0.3000
A	0.2877	0.2880	В	0.2953	0.3000
	0.2810	0.2760		0.2820	0.2760
	0.2703	0.3000		0.2836	0.3240
6	0.2836	0.3240		0.2969	0.3480
C	0.3086	0.3240	D	0.3219	0.3480
	0.2953	0.3000		0.3086	0.3240
	0.2916	0.3240			
E	0.2982	32 0.3360			
E	0.3141	0.3360			
	0.3075	0.3240			

4. Bin Range of Chromaticity Coordinates

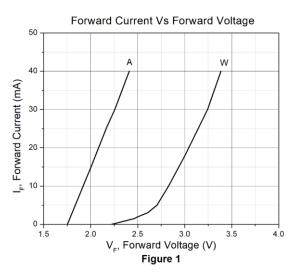


Tolerance of Dominant Wavelength: ± 1 nm.

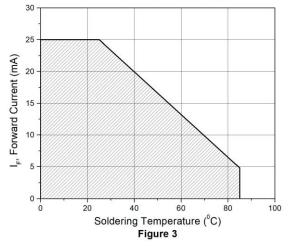


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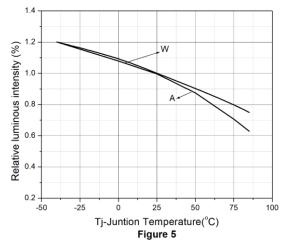
Typical Characteristic Curves

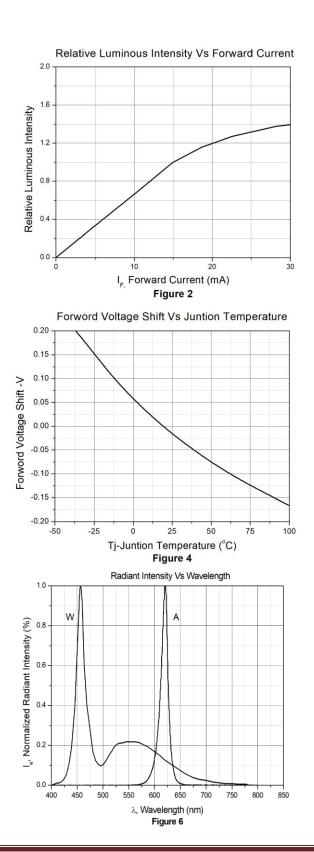


Forward Current Vs Soldering Temperature



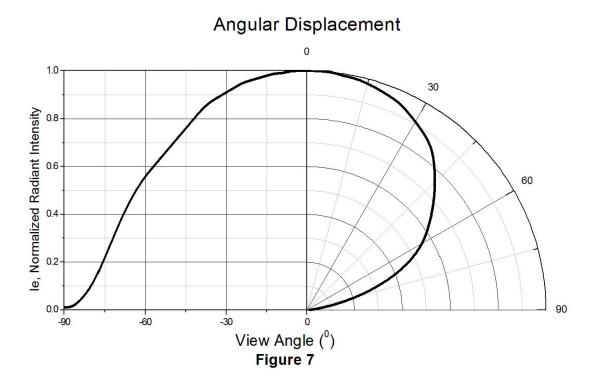
Relative Luminous Intensity Vs Juntion Temperature





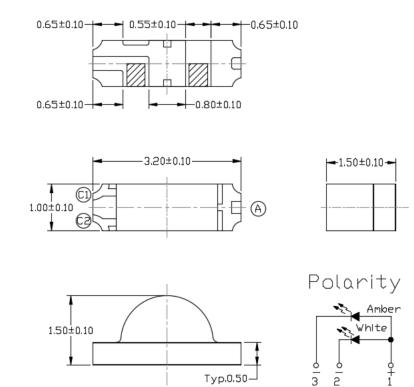


Typical Characteristic Curves



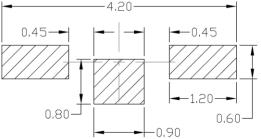


Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



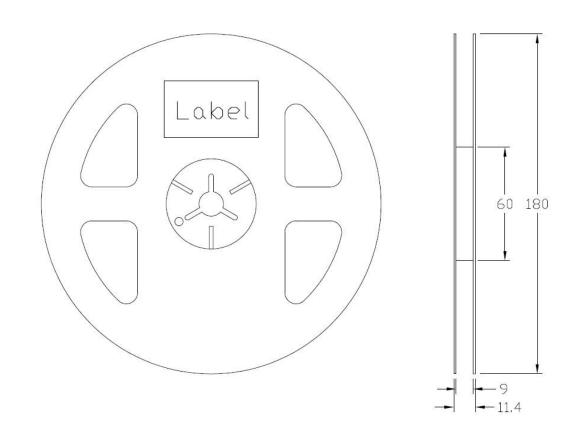
Note: Tolerance unless mentioned is ±0.1mm.

Ordering Information

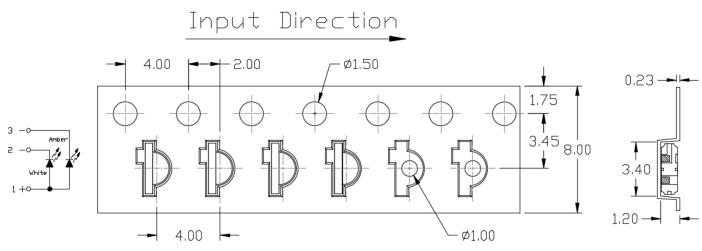
Part Number	Description	Quantity
WAP321015-PCSC2	Tape & Reel	2000 pcs



Reel Dimension All dimensions are in mm, unless otherwise stated



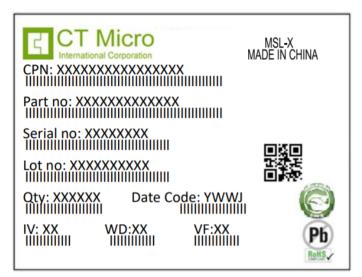
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



Label Form Specification



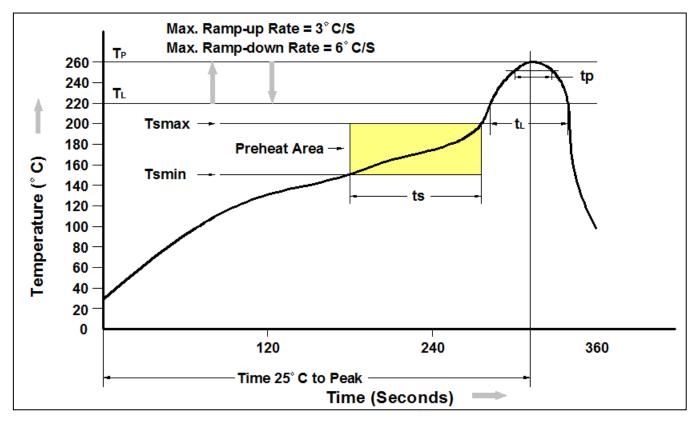
CPN : Customer Part Number Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date IV : Bin Code of Luminous Intensity WD : Bin Code of Dominant Wavelength VF : Bin Code of Forward Voltage MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T∟)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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